



Technology Metals | Advanced Ceramics

# Highest capacitance at higher voltages: Pushing the limits of tantalum high voltage capacitors

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# High Voltage Market Trends: Focus High Reliability

Increasing demand for HV applications!

**Data Storage (SSD)**



**Medical Devices**



**Aviation**



**Aerospace**



**Transportation and  
Railroad**



**Automotive**



**Defense**

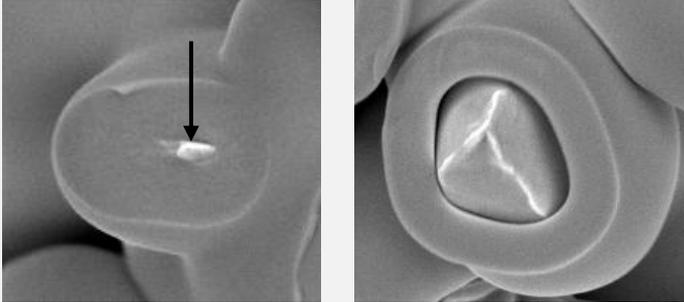


# High Voltage Medium Capacitance - HVMC

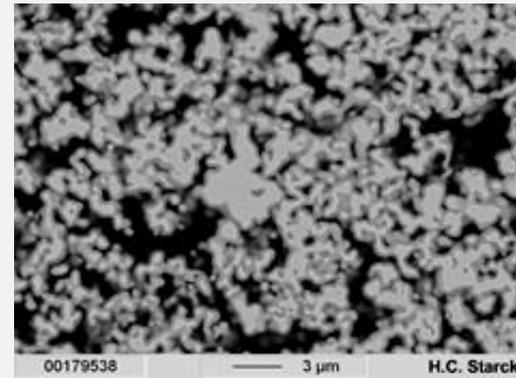
- Main focus at H.C. Starck: New powders with formation voltages 50 - 350 V<sub>f</sub>

## 1. Suitable large primary particle size

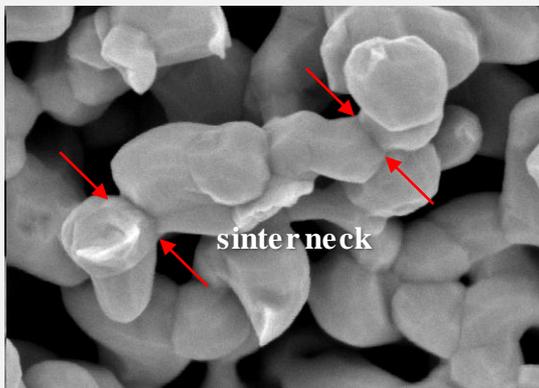
tantalum core



## 3. Sufficiently large pore size diameter



## 2. Sufficiently strong (thick) sinter necks



## 4. Good homogeneity of 1-3

## 5. High Purity



New high voltage powder generation requires improved microstructure!

# Capability of Different Tantalum Powder Processes

Powder Type

+ Advantages

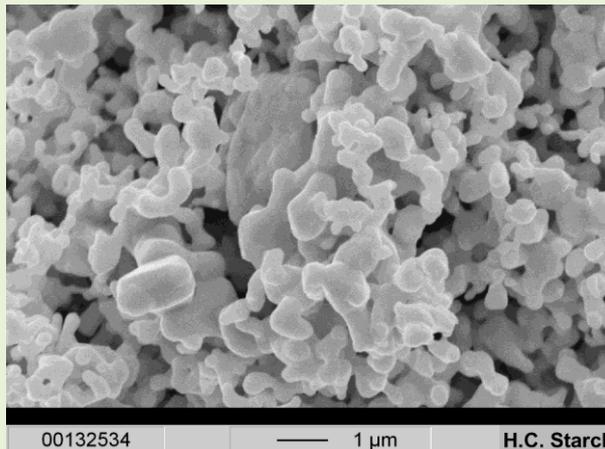
- Disadvantages

Main Focus  
(Past)

Microstructure  
(showcase)

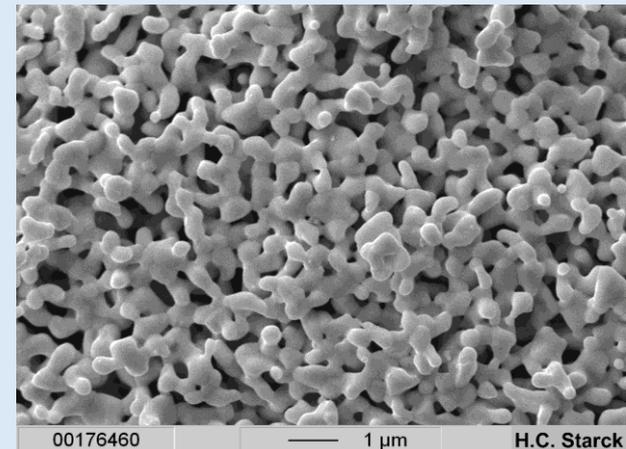
Na Reduced

- Large pores
- Large primary particles
- Less homogenous powder
- Low CV / high voltage



Mg Reduced

- Very homogenous morphology
- Higher purity
- Small pores (< 400 nm)
- Too small primary particles
- High CV / low voltage

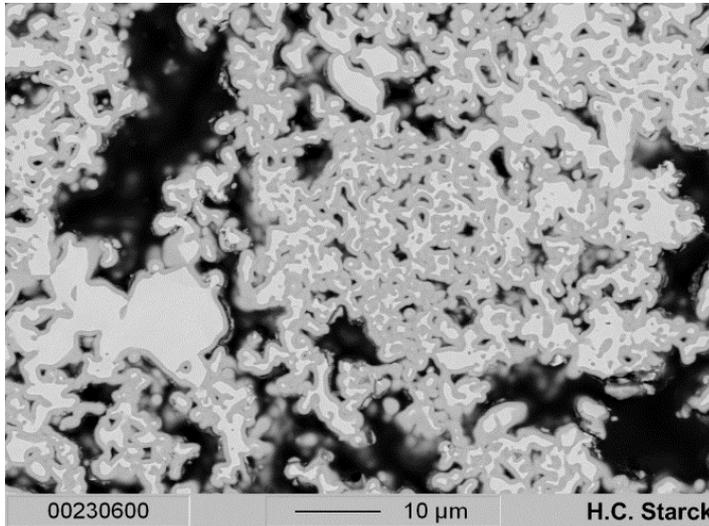


→ HVMC combining the advantages of both powder types!

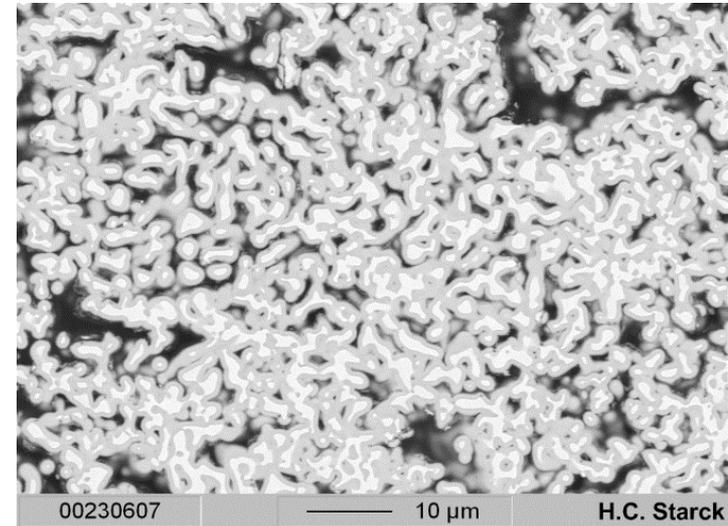
# Comparing the Micro Structure: HV300 vs. Standard Anode

## Cross Section of 300 V formed anodes

12k  $\mu\text{FV/g}$  Anode



HV300 Anode

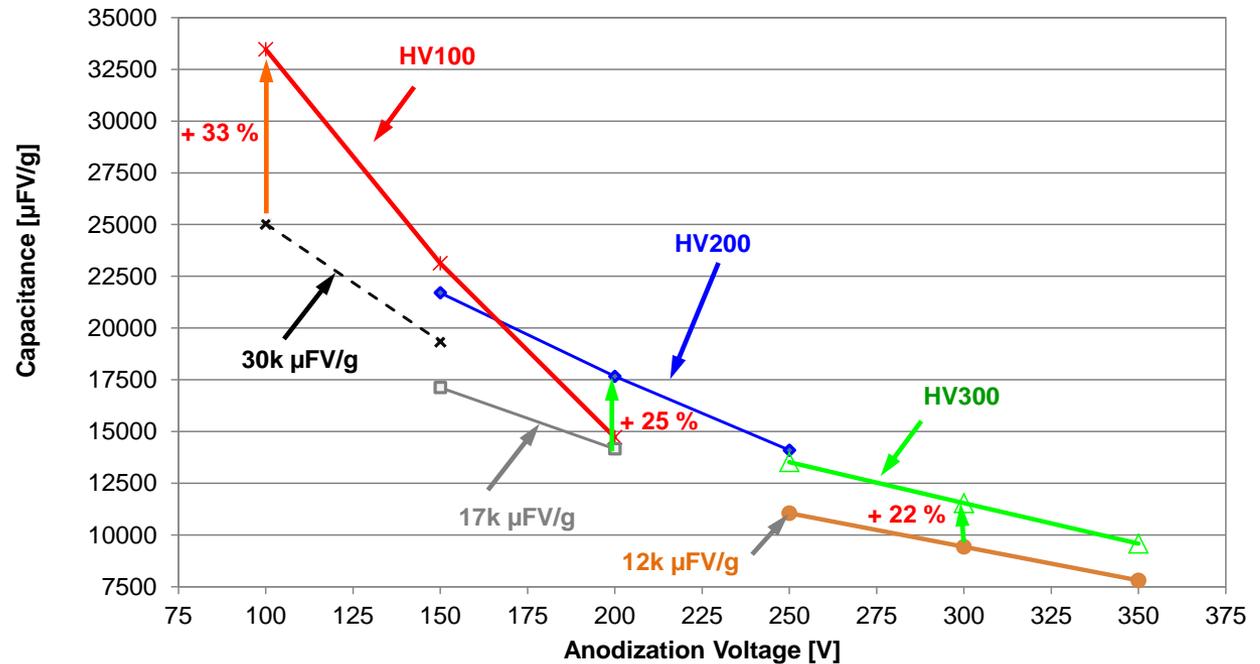
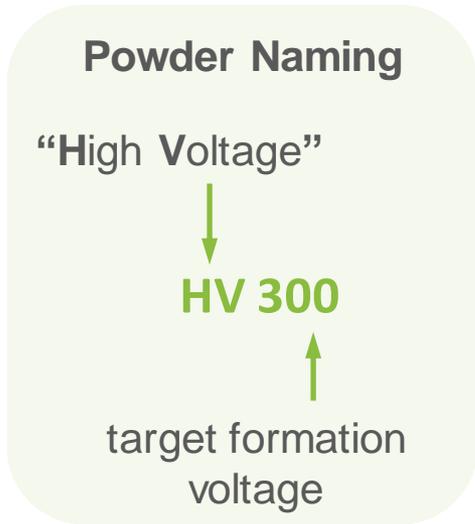


- Large variation of primary particle size
- Large variation of pore size, wasted space

- ✓ Superior microstructural homogeneity
- ✓ More uniform pores and particles

Improved HVMC microstructure is responsible for highest cap!

# HVMC: Highest Capacitance for 100 – 350 V



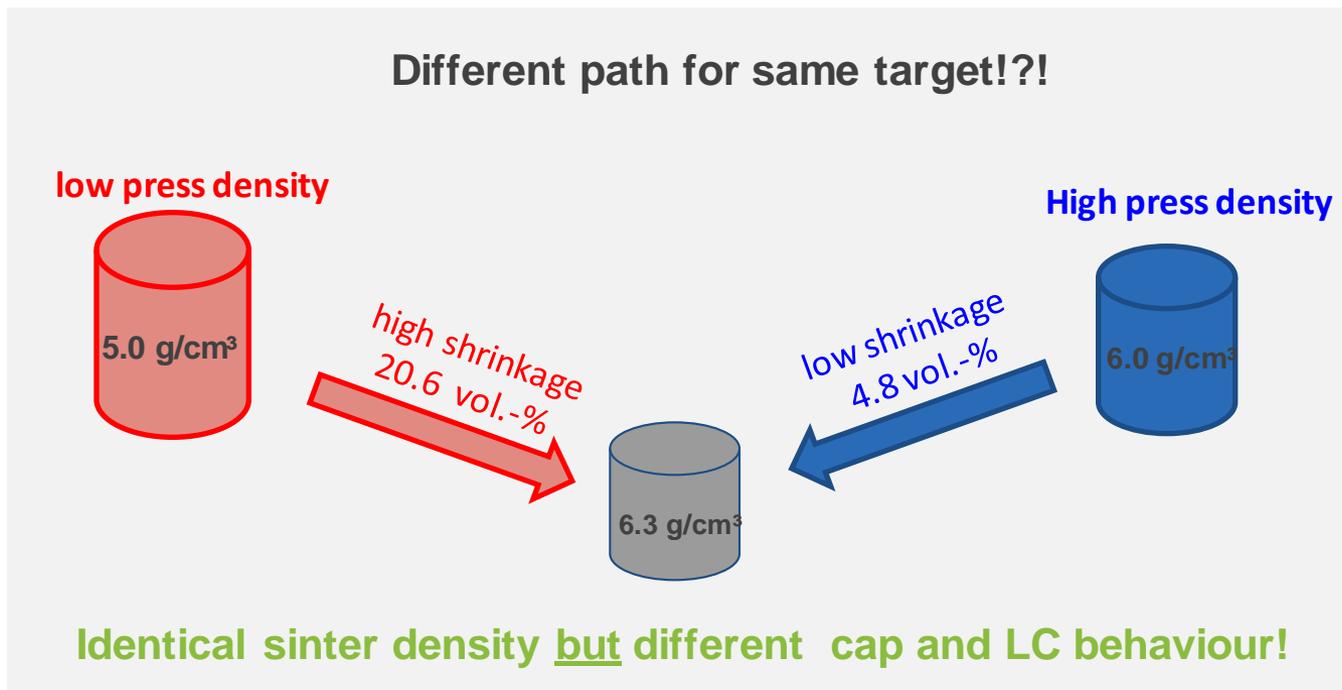
- HVMC give highest cap at each formation voltage!
- Superior microstructural homogeneity of pores and particles
  - High dielectric strength
  - High reliability
  - Highest energy density

## Finding the Optimum

Impact of pressing and sintering for 300 V<sub>f</sub>

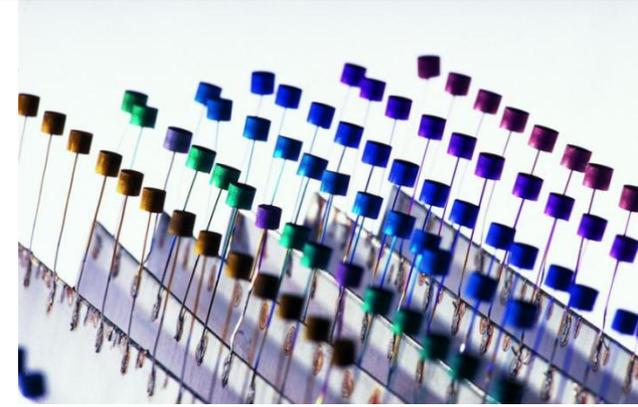
## Highest Energy Density at 300 V<sub>f</sub>: HV 300

- **Task**                    Determination of optimum pressing and sintering condition for HV 300  
                                  → Finding maximum CV/cm<sup>3</sup> and good leakage current/BDV behavior
- **Problem**                Best powder will failure when wrong conditions are applied!  
                                  **!! Each powder and anodization voltage has its own optimum!!**

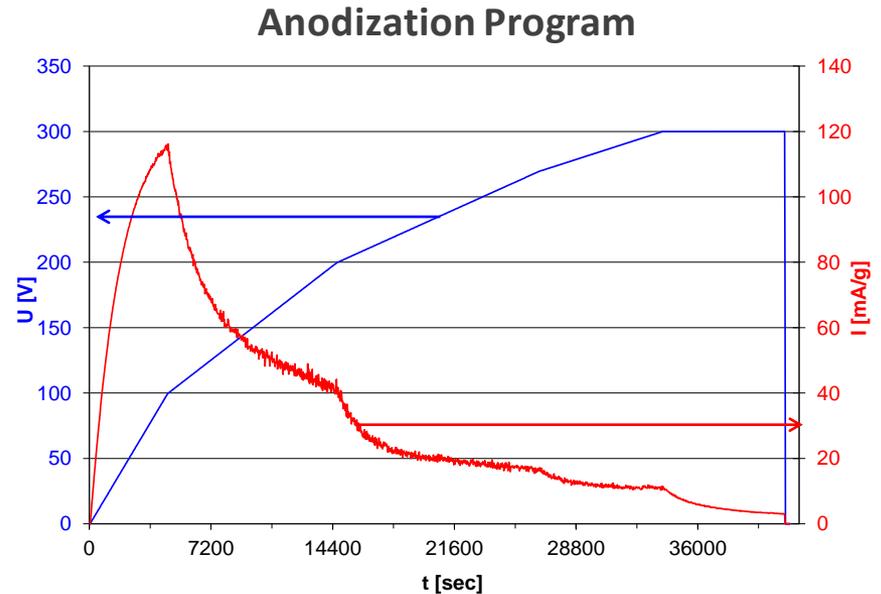
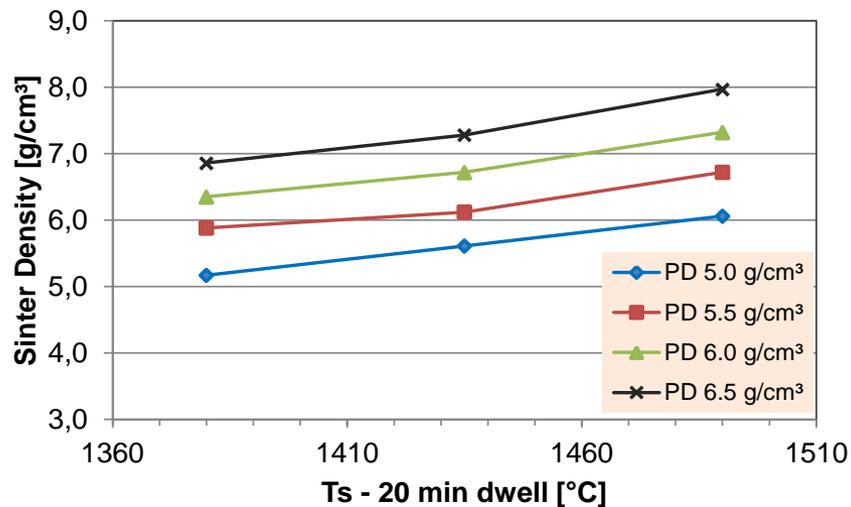


# Experimental Part

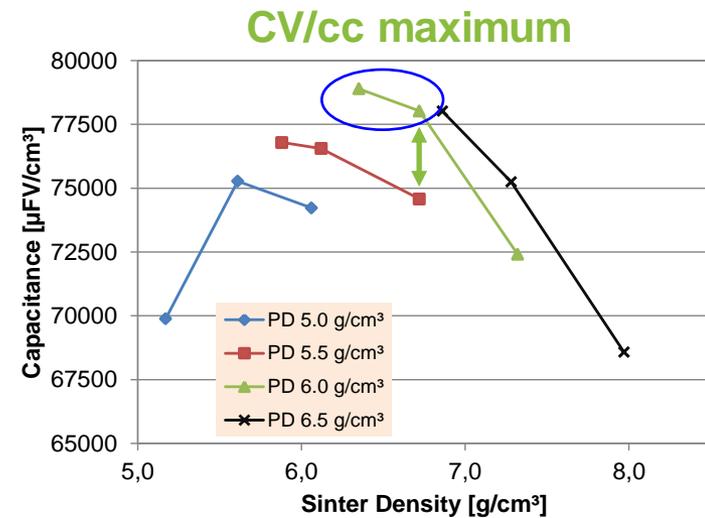
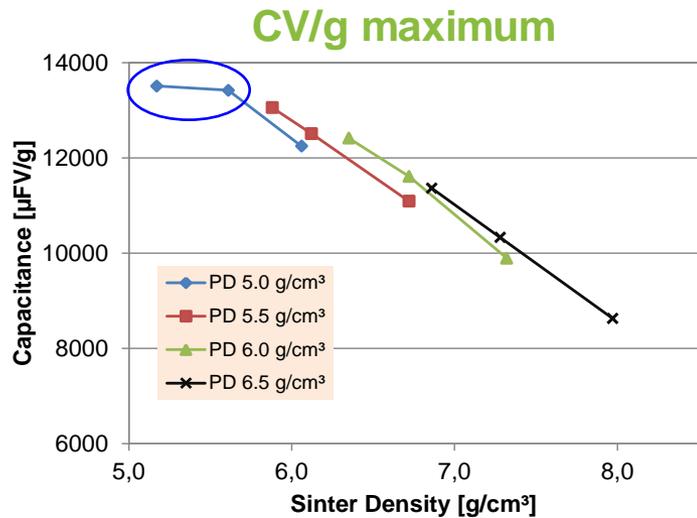
- Press density 5.0 – 6.5 g/cm<sup>3</sup> (0.5 g/cm<sup>3</sup> steps)
- Sintering 3 temperatures → 5, 10, 16 vol.-% (±1 %)
- Diameter 3 mm



- Different anode sizes and anodization conditions have also an impact
- However, general tendencies are comparable!

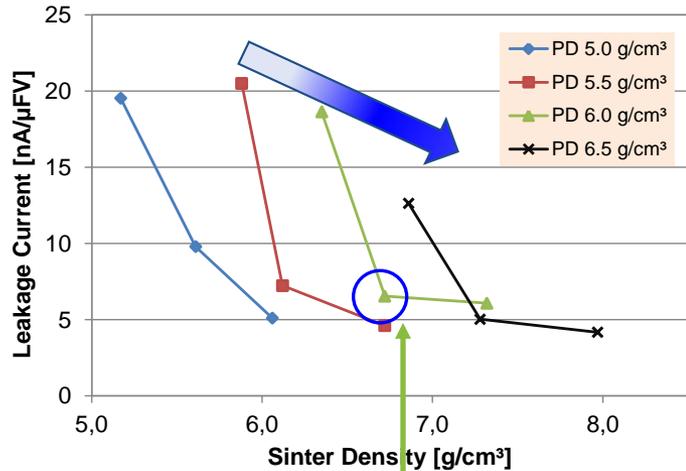


# HV 300: Capacitance Data @ 300 V<sub>f</sub>

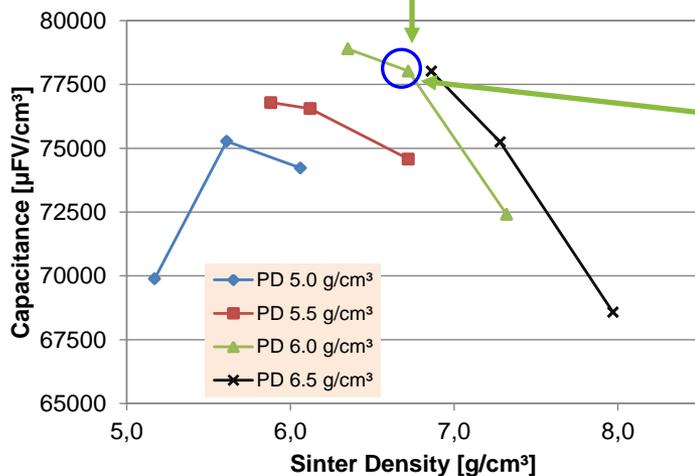


- Powder has highest CV/g → increased pressing and shrinkage reduces always CV/g
- But: Higher press density increases the powder amount per volume
- If pressing density is too high: pore closing effect will be higher and can not be compensated by more powder and causes bad impregnation behavior
- This optimum depends on
  - a) Powder type
  - b) Anodization Voltage

# HV 300: Leakage Current @ 300 V<sub>f</sub>



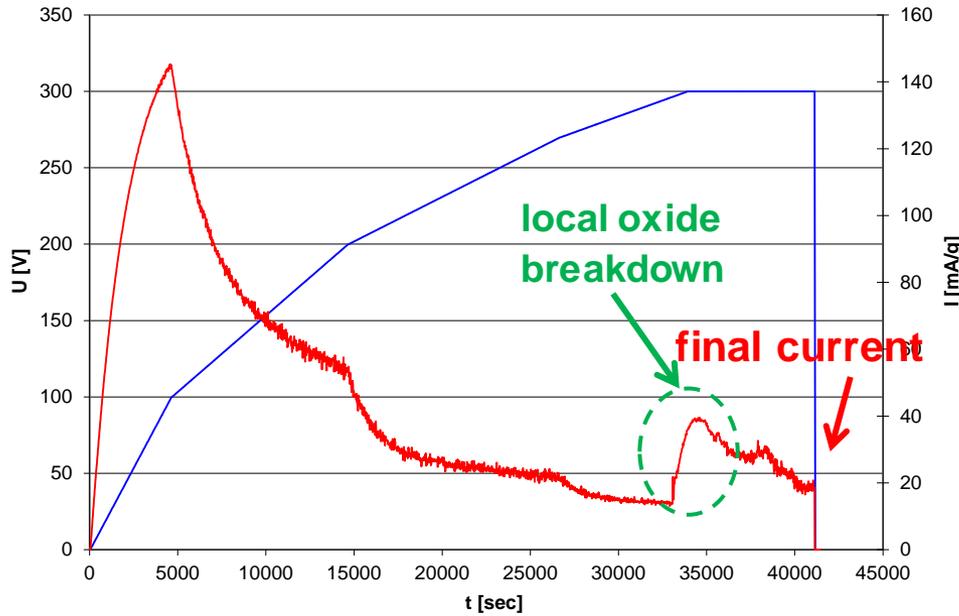
- Increased press density improves LC
  - Increased shrinkage improves LC
  - Significant improvement from 5 → 10 % shrinkage
- ➔ Best conditions is compromise between LC and cap



**Recommendation:**  
**PD 6.0 g/cm<sup>3</sup> and ~10 vol.-% for 300 V**

# HV 300: Anode Breakdown

PD 5.0 g/cm<sup>3</sup> 4 % Shrinkage



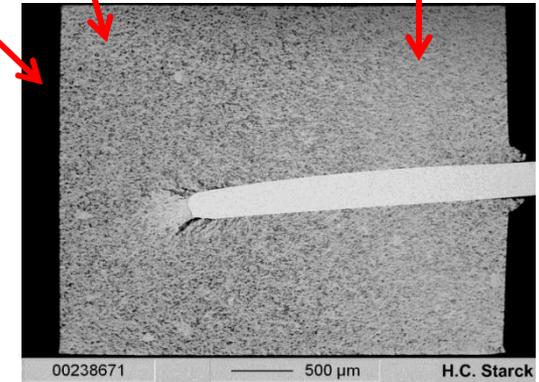
- Too weak anode strength causes anode breakdown and high LC!

breakdown starts here

Impact of pressing gradient

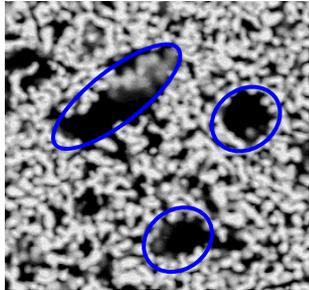
lower PD

higher PD

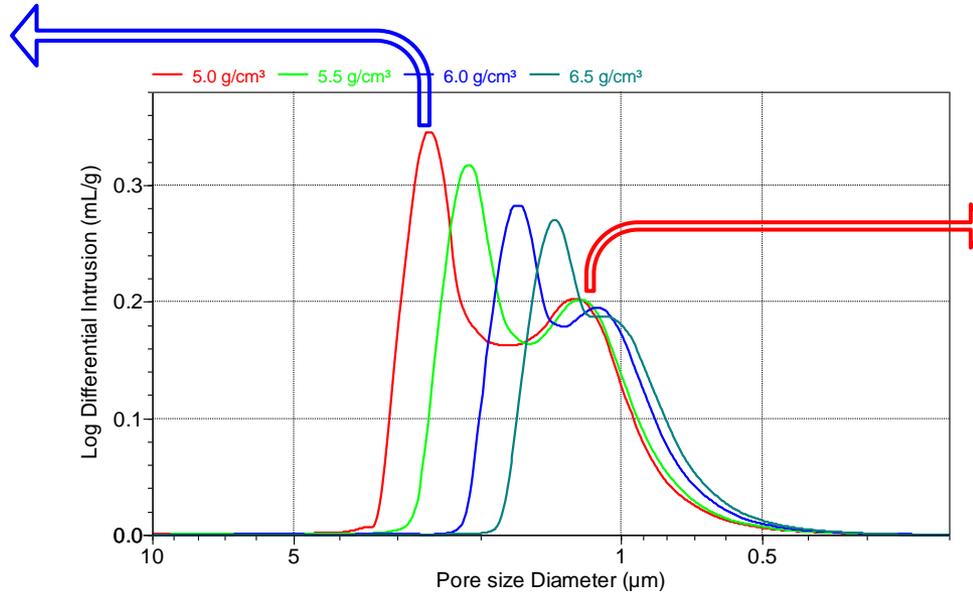


# Anode Pores: Effect of Pressing

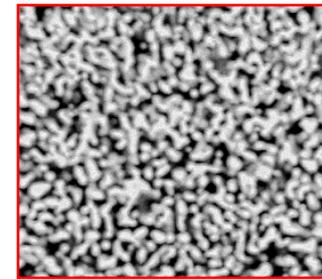
secondary pores



Pore shift by pressing



primary pores



- Primary pores are responsible for capacitance (strong impact on anode surface)
- Secondary pores are beneficial for infiltration: space between adjacent agglomerates
- The higher the press density the lower the total pore volume → pore shift to smaller values
- Increased press density increases also the contact area of adjacent agglomerates

## Summary

- ✓ HVMC enable the production of new high voltage capacitor → delivers more cap than Na standard powders
  - ✓ Provide an increase in volumetric efficiency → supporting the trend toward miniaturization.
- 
- ✓ Pressing and sintering has a strong impact on capacitance and leakage current and breakdown behavior
  - ✓ Best powder will fail if wrong conditions are applied
  - ✓ Optimum condition for HV300: Press density of 6.0 g/cm<sup>3</sup> and 10 vol.-% provides high CV/cm<sup>3</sup> and good leakage current



**Dr. Marcel Hagymási**

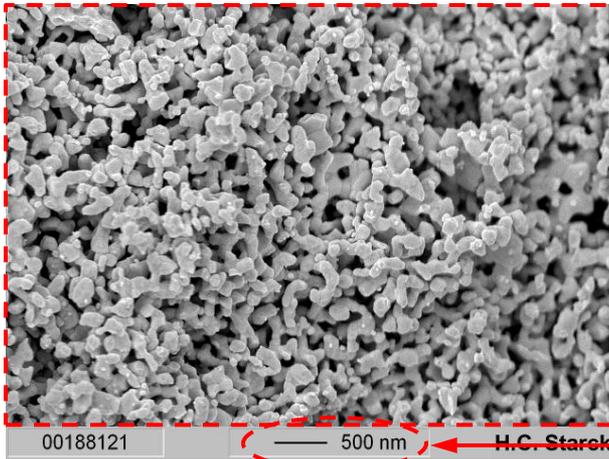
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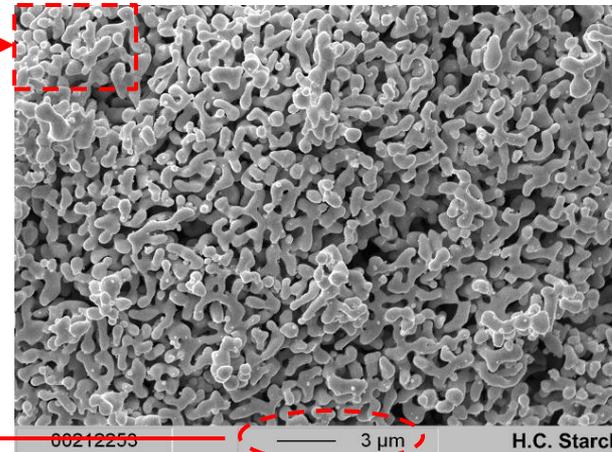
# Microstructure of HVMC Anodes

Increasing the dimensions but keep the structure homogeneous!

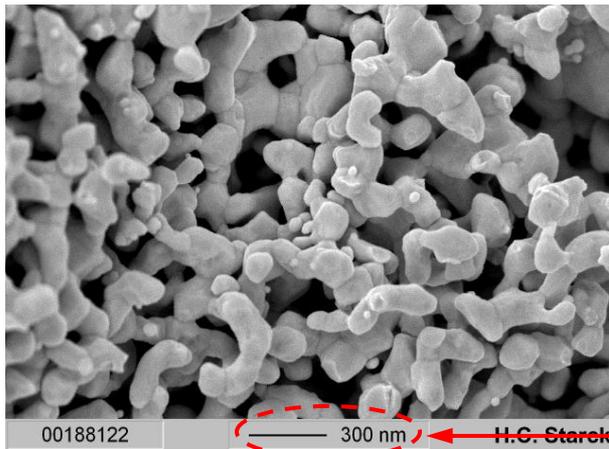
STA150KA  
6 V-20 V



HV200  
150 V-200 V



5 x higher magnification



5 x higher

